

# HSS82

Silicon Epitaxial Planar Diode for High Voltage Switching

REJ03G0569-0300 (Previous: ADE-208-176B) Rev.3.00 Mar 22, 2005

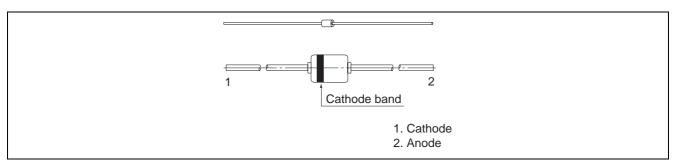
### Features

- High reverse voltage. ( $V_R = 200 \text{ V}$ )
- Suitable for 5 mm pitch high speed automatically insertion.
- Small glass package (MHD) enables easy mounting and high reliability.

### **Ordering Information**

Type No.	Cathode band	Package Name	Package Code (Previous Code)
HSS82	Navy Blue	MHD	GRZZ0002ZC-A
			(MHD)

### **Pin Arrangement**





## **Absolute Maximum Ratings**

			$(Ta = 25^{\circ}C)$
Item	Symbol	Value	Unit
Peak reverse voltage	V <sub>RM</sub> * <sup>1</sup>	250	V
Reverse voltage	V <sub>R</sub>	200	V
Average rectified current	lo	150	mA
Peak forward current	I <sub>FM</sub>	625	mA
Non-Repetitive peak forward surge current	I <sub>FSM</sub> * <sup>2</sup>	1	А
Power dissipation	Pd	400	mW
Junction temperature Tj		200	°C
Storage temperature	Tstg	–65 to +175	°C

Notes: 1. Reverse voltage in excess of peak reverse voltage may deteriorate electrical characteristic.

2. Within 1s forward surge current.

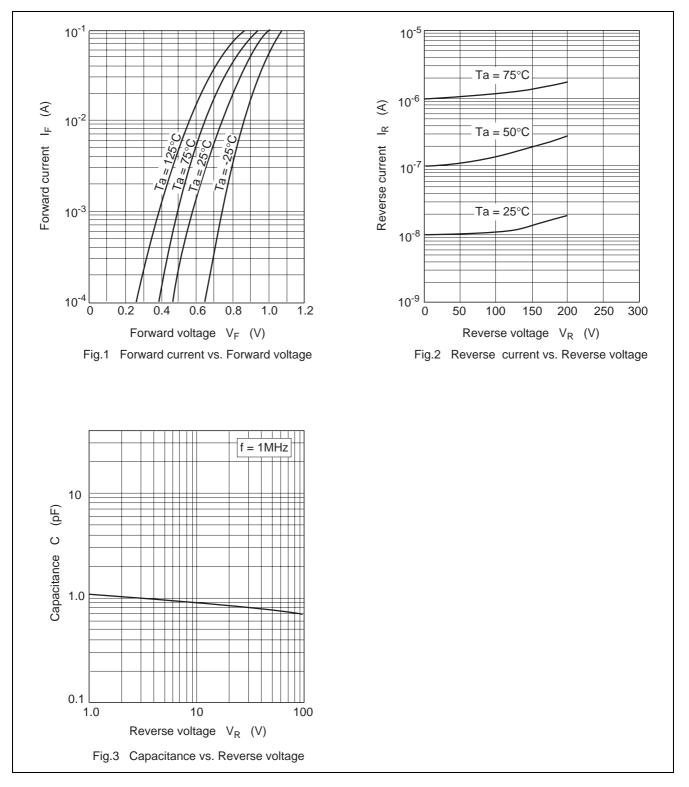
### **Electrical Characteristics**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse current	I <sub>R1</sub>	—	-	200	nA	V <sub>R</sub> = 200 V
	I <sub>R2</sub>	—		100	μA	V <sub>R</sub> = 250 V
Forward voltage	VF	_		1.0	V	I <sub>F</sub> = 100 mA
Capacitance	С	_	1.5	_	pF	V <sub>R</sub> = 0 V, f = 1 MHz
Reverse recovery time	t <sub>rr</sub>	_	_	100	ns	$I_F$ = $I_R$ = 30 mA, Irr = 3 mA, $R_L$ = 100 $\Omega$

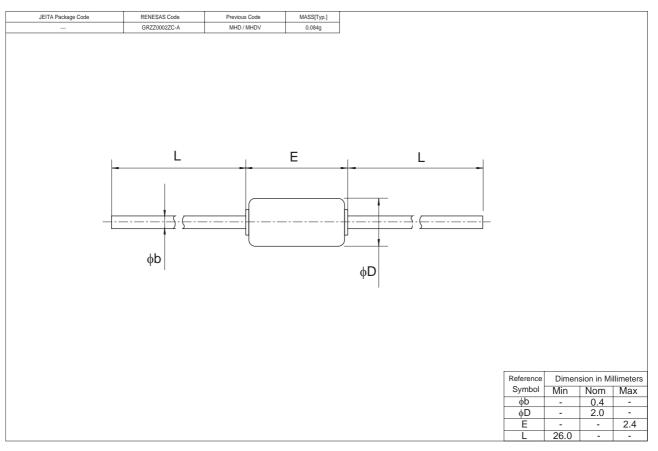


### **Main Characteristic**





# Package Dimensions





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